Unit: mm

7.62±0.25

TOSHIBA Photocoupler IRED & Photo-Diode Array

# TLP591B

Telecommunications Programmable Controllers MOS Gate Drivers MOSFET Gate Drivers

**FOSHIBA** 

The TOSHIBA TLP591B consists of an infrared emitting diode optically coupled to a series-connected photo-diode array in a six-lead plastic DIP package.

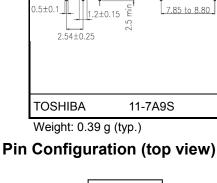
The TLP591B is suitable for MOS FET gate drivers.

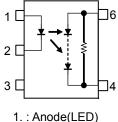
The TLP591B has an internal shunt resistor to optimize switching speed.

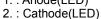
• UL-recognized: UL 1577, File No.E67349

#### Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit
	Forward current	lF	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔIF /°C	-0.5	mA /°C
	Pulse forward current (100 µs pulse, 100 pps)	IFP	1	А
LED	Reverse voltage	VR	3	V
	Diode power dissipation	PD	100	mW
	Diode power dissipation derating (Ta ≥25°C)	ΔP <sub>D</sub> /°C	-1.0	mW/°C
	Junction temperature	Tj	125	°C
	Forward current	I <sub>FD</sub>	50	μA
Detector	Reverse voltage	V <sub>RD</sub>	10	V
Dete	Output power dissipation	Po	0.5	mW
	Junction temperature	Tj	125	°C
Stor	age temperature range	T <sub>stg</sub>	-55 to 125	°C
Ope	rating temperature range	Topr	-40 to 85	°C
Lea	d soldering temperature (10 s)	T <sub>sol</sub>	260	°C
	ation voltage , 60 s, R.H. ≤ 60 %) (Note 1)	BVS	2500	V <sub>rms</sub>







3. : NC

6. : Anode

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba

Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two terminal device: Pins 1, 2 and 3 shorted together, and pins 4 and 6 shorted together.

<sup>4. :</sup> Cathode

#### **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit	
Forward current	lF	_	20	25	mA	
Operating temperature	Topr	-25	-	85	°C	

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

#### **Electrical Characteristics (Ta = 25°C)**

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.2	1.4	1.7	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 3 V	_	_	10	μA
	Capacitance	CT	V = 0 V, f = 1 MHz	_	30	60	pF
Detector	Forward voltage	VFD	I <sub>FD</sub> = 10 μA		7		V
Dete	Reverse current	I <sub>RD</sub>	V <sub>RD</sub> = 10 V	_	7	_	μA

#### Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Open voltage	Voc	IF = 20 mA	7	8	_	V
Short Current	Isc	IF = 20 mA	24	40		μA

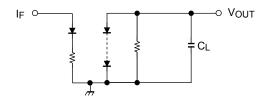
#### **Isolation Characteristics (Ta = 25°C)**

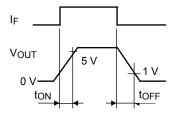
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance (input to output)	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5×10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVs	AC, 60 s	2500			Vrms

#### Switching Characteristics (Ta = 25°C)

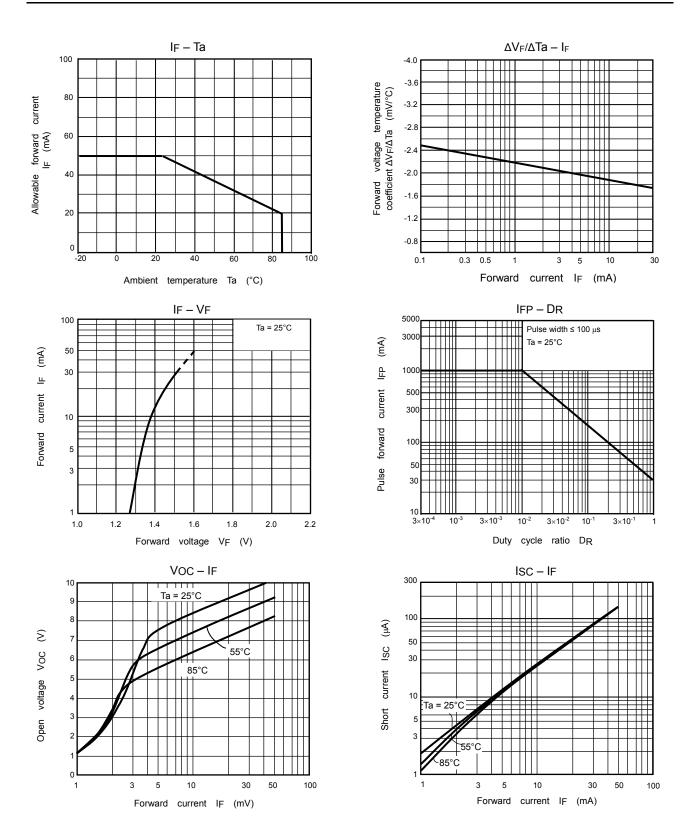
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	IF = 20 mA, CL = 1000 pF	—	0.2	_	ms
Turn-off time	tOFF	(Note 2)		3	_	ms

Note 2: Switching time test circuit





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NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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